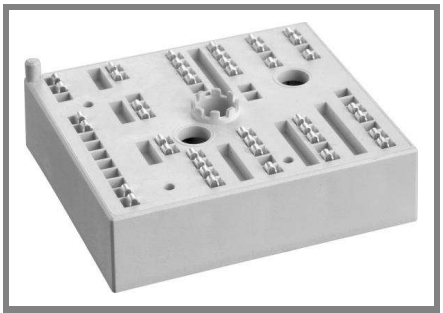


MiniSKiiP®2

H-bridge inverter

SKiiP 27GH066V1

Features

- Trench IGBTs
- Robust and soft freewheeling diode in CAL technology
- Highly reliable spring contacts for electrical connection
- UL recognised file no. E63532

Typical Applications*

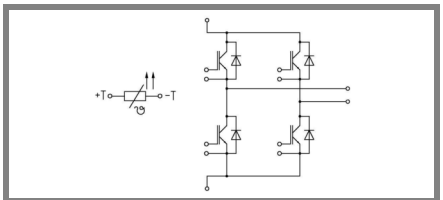
- Single-phase inverter up to 14 kVA
- Single-phase motor power 5.5 kW

Remarks

- Case temperature limited to T_C = 125°C
- Product reliability results are valid for T_j = 150°C
- SC data: $t_p \leq 6$ s; $V_{GE} \leq 15$ V; T_j = 150°C, V_{CC} = 360 V
- V_{CEsat}, V_F= chip level value

Absolute Maximum Ratings		T_S = 25 °C, unless otherwise specified	
Symbol	**Conditions**	**Values**	**Units**
IGBT - Inverter			
V_{CES}		600	V
I_C	T_s = 25 (70) °C ,T_j = 150 °C	79 (53)	A
I_C	T_s = 25 (70) °C ,T_j = 175 °C	88 (65)	A
I_{CRM}	t_p = 1 ms	150	A
V_{GES}		± 20	V
T_j		-40...+175	°C
Diode - Inverter			
I_F	T_s = 25 (70) °C ,T_j = 150 °C	65 (42)	A
I_F	T_s = 25 (70) °C ,T_j = 175 °C	77 (56)	A
I_{FRM}	t_p = 1 ms	150	A
T_j		-40...+175	°C
I_{tRMS}	per power terminal (20 A / spring)	100	A
T_{stg}	$T_{op} \leq T_{stg}$	-40...+125	°C
V_{isol}	AC, 1 min.	2500	V

Characteristics		T_S= 25 °C, unless otherwise specified			
Symbol	**Conditions**	**min.**	**typ.**	**max.**	**Units**
IGBT - Inverter					
V_{CEsat}	I_{Cnom} = 75 A ,T_j = 25 (150) °C	1,05	1,45 (1,65)	1,85 (2,05)	V
$V_{GE(th)}$	$V_{GE} = V_{CE}$, I_C = 1 mA		5,8		V
$V_{CE(TO)}$	T_j = 25 (150) °C		0,85 (0,7)	1,1 (1)	V
r_T	T_j = 25 (150) °C		8 (12,7)	10,7	mΩ
C_{ies}	V_{CE} = 25 V, V_{GE} = 0 V, f = 1 MHz		4,4		nF
C_{oes}	V_{CE} = 25 V, V_{GE} = 0 V, f = 1 MHz		0,78		nF
C_{res}	V_{CE} = 25 V, V_{GE} = 0 V, f = 1 MHz		0,66		nF
$R_{CC'+EE'}$	spring contact-chip T_s = 25 (150)°C				mΩ
$R_{th(j-s)}$	per IGBT		0,75		K/W
$t_{d(on)}$	under following conditions		115		ns
t_r	V_{CC} = 300 V, V_{GE} = -8V/+15V		45		ns
$t_{d(off)}$	I_{Cnom} = 75 A, T_j = 150 °C		475		ns
t_f	$R_{Gon} = R_{Goff}$ = 6,2 Ω		60		ns
$E_{on}(E_{off})$	inductive load		2,7 (3)		mJ
Diode - Inverter					
$V_F = V_{EC}$	I_{Fnom} = 75 A ,T_j = 25 (150) °C		1,5 (1,5)	1,7 (1,7)	V
$V_{(TO)}$	T_j = 25 (150) °C		1 (0,9)	1,1 (1)	V
r_T	T_j = 25 (150) °C		6,7 (8)	8 (9,3)	mΩ
$R_{th(j-s)}$	per diode		1,2		K/W
I_{RRM}	under following conditions		52		A
Q_{rr}	I_{Fnom} = 75 A, V_R = 300 V		8		C
E_{rr}	V_{GE} = 0 V, T_j = 150 °C		1,8		mJ
	di_F/dt = 1480 A/ s				
Temperature Sensor					
R_{ts}	3 %, T_r = 25 (100) °C		1000(1670)		Ω
Mechanical Data					
m			65		g
M_s	Mounting torque	2		2,5	Nm



GH

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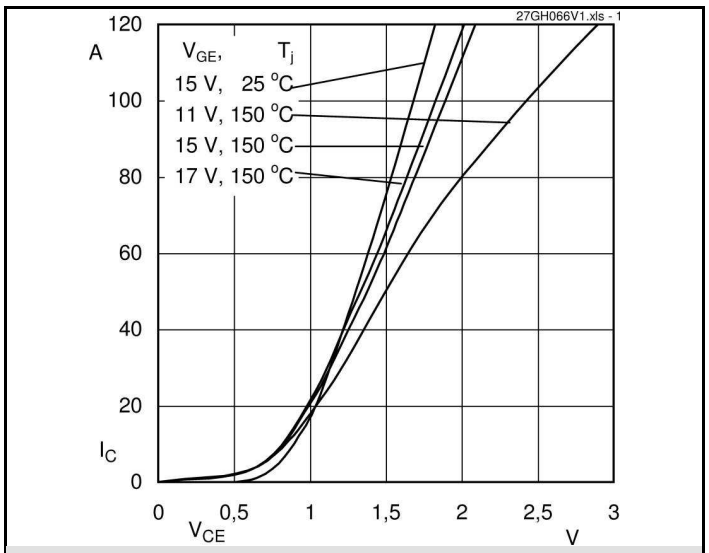

Fig. 1 Output characteristic

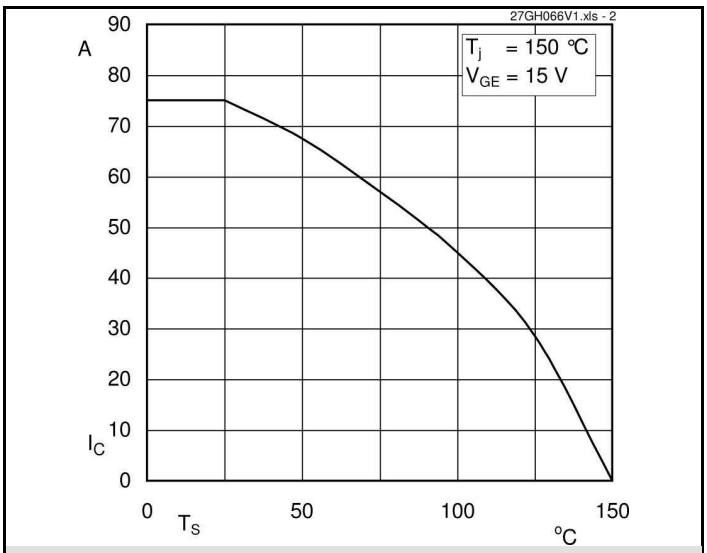

Fig. 2 Rated current vs. temperature

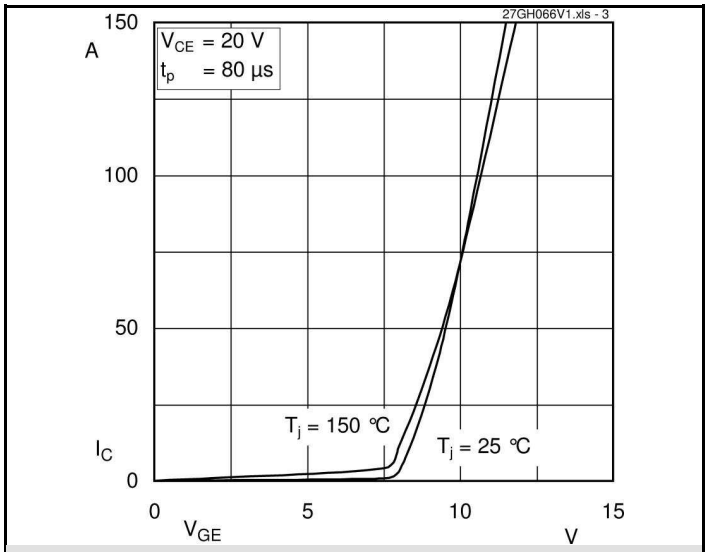

Fig. 3 Typ. transfer characteristic

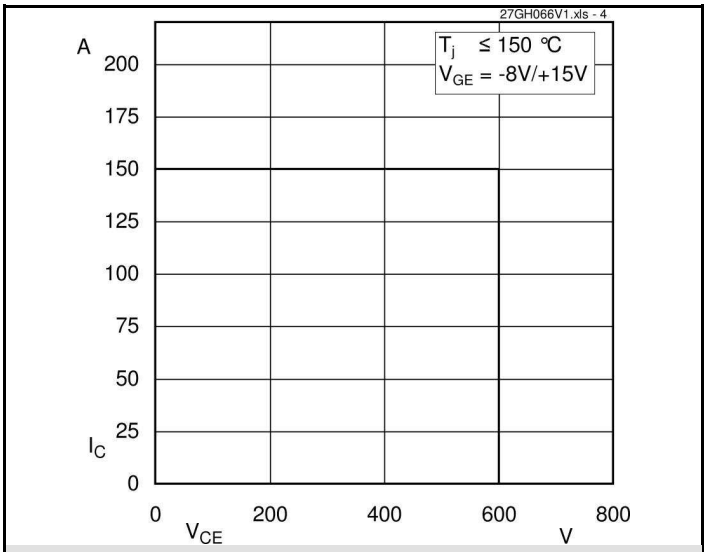

Fig. 4 Reverse bias safe operating area

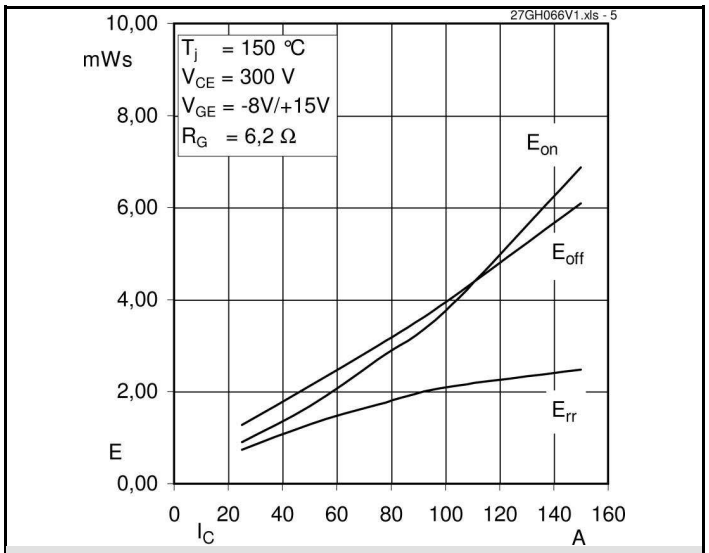

Fig. 5 Typ. turn-on /-off energy = f (I_C)

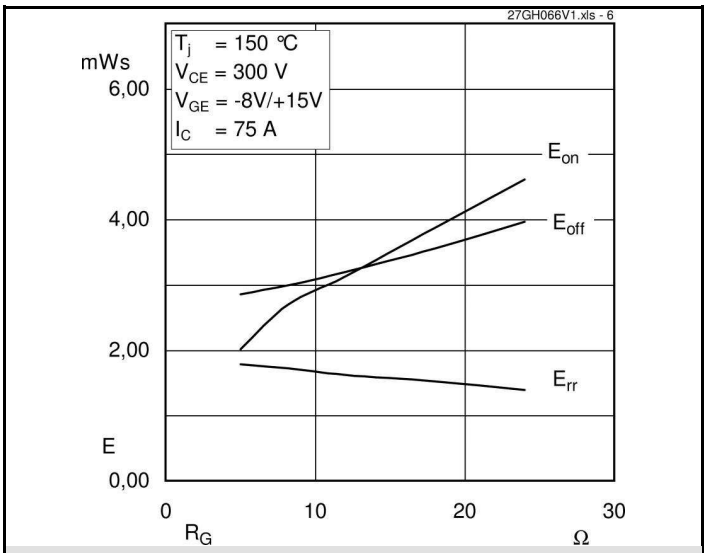

Fig. 6 Typ. turn-on /-off energy = f (R_G)

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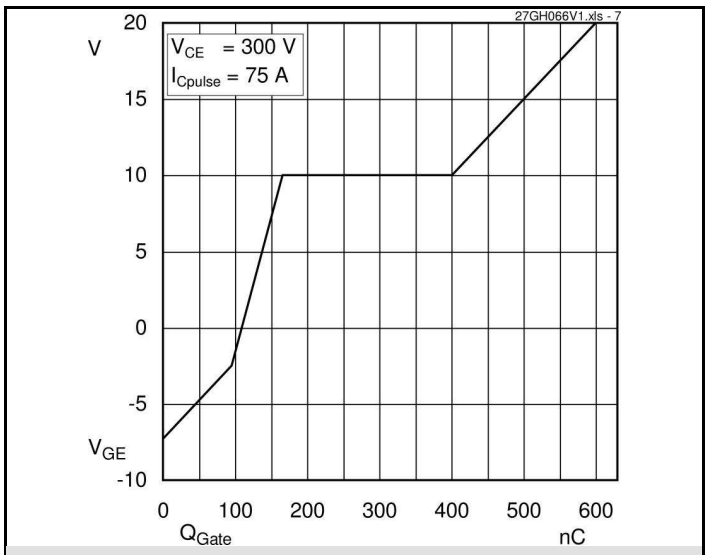

Fig. 7 Typ. Gate charge characteristic

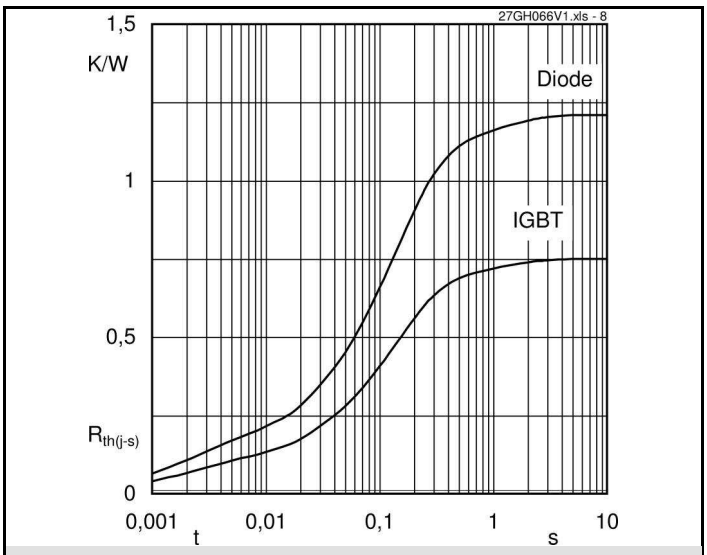

Fig. 8 Thermal impedance

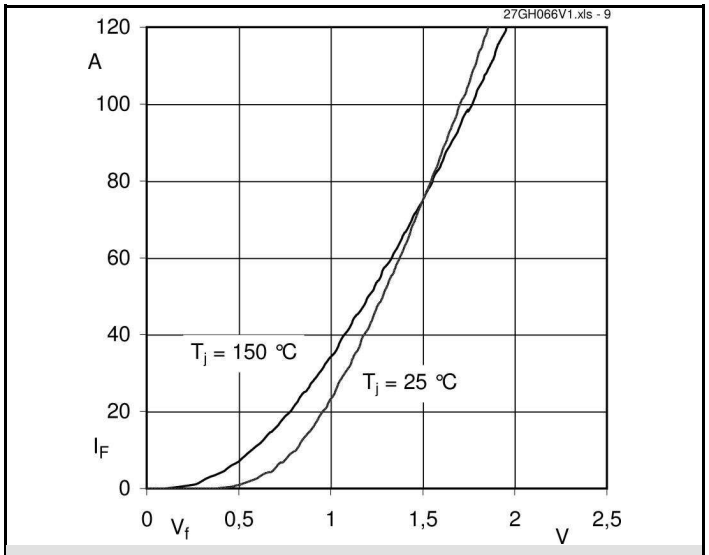

Fig. 9 Freewheeling diode forward characteristic

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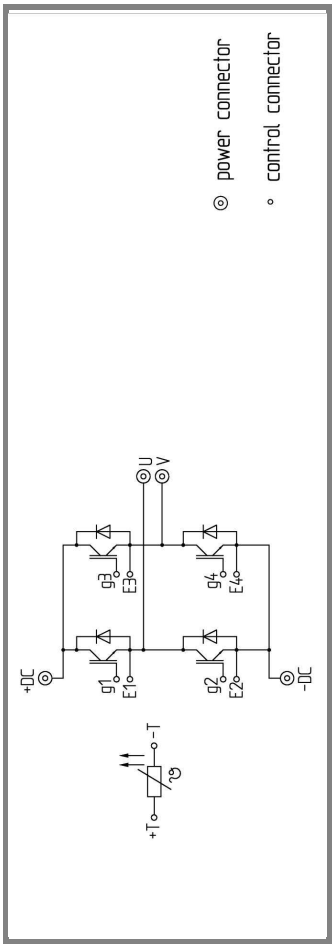
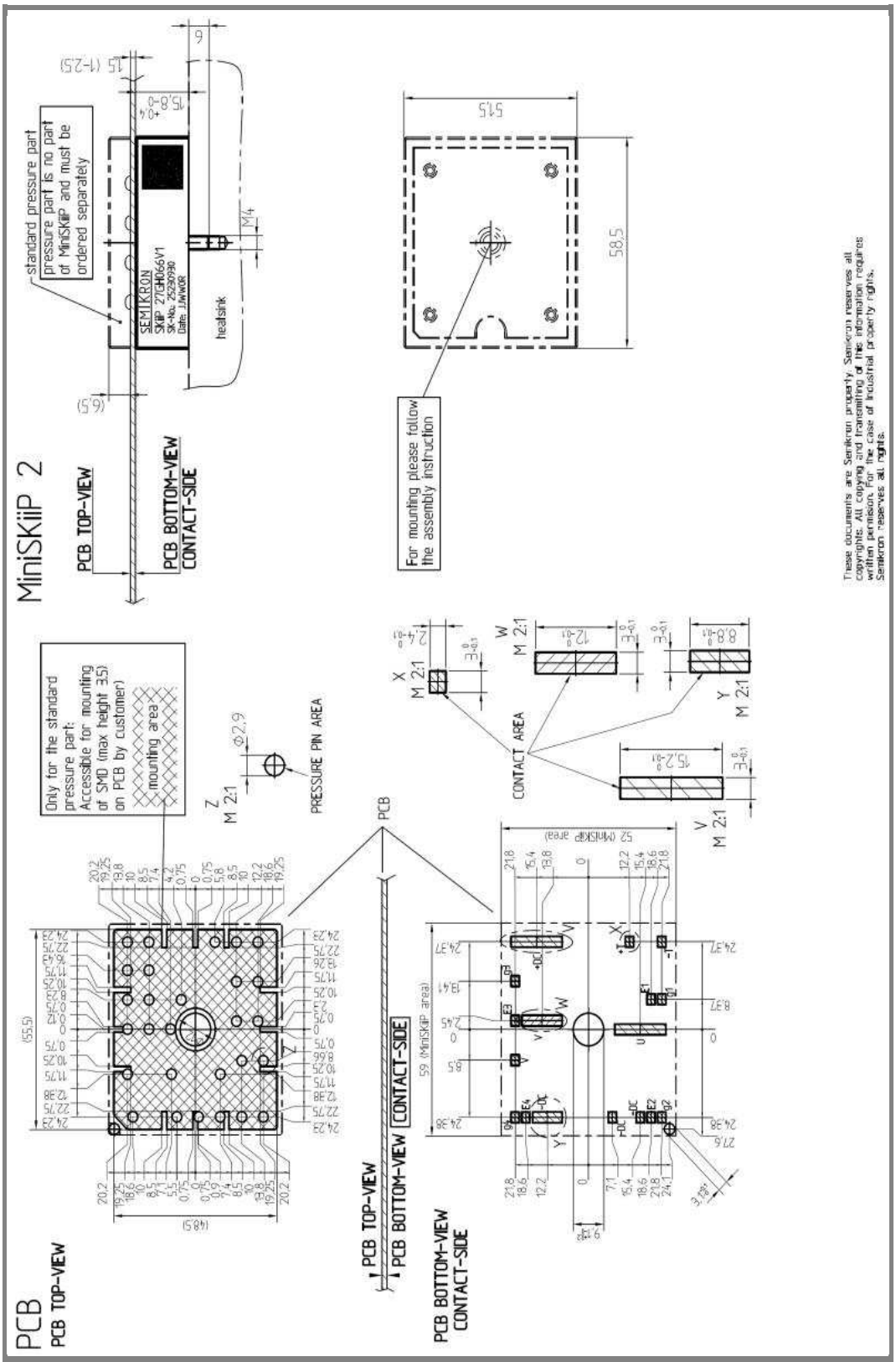


circuit



pinout, dimensions

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.

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